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27 MHz Clock Generator with VCXO

Features

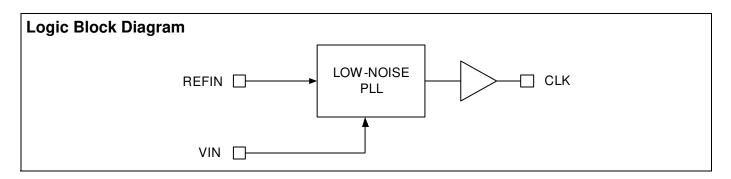
- Generates 27 MHz Output Clock
- Uses 27 MHz LVCMOS Reference Clock
- LVCMOS Output
- VCXO with 230 ppm Minimum Pull Range
- Fully Integrated Low Noise Phase Locked Loop (PLL)
- Linear Voltage-to-Frequency Control Curve
- Supply Voltage: 3.3V
- Pb-free 16-Pin TSSOP Package

Description

The CY2VC511 is a PLL based clock generator with VCXO control. It takes a low swing 27 MHz reference clock, and generates an adjustable 27 MHz output clock. The device has a single LVCMOS output and operates from a 3.3V power supply.

The VIN pin is an analog input that enables the user to pull the output frequency. The pullability range is at least 230 ppm (±115 ppm). The pull curve is very linear.

Unlike conventional VCXO designs, the output frequency adjustment is achieved by a proprietary PLL design. This permits the use of 27 MHz clock reference.



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Pinout

Figure 1. Pin Diagram - 16-Pin TSSOP

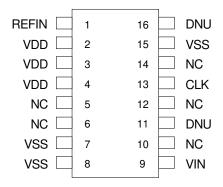


Table 1. Pin Definitions - 16-Pin TSSOP

| Pin | Name | Туре | Description | |
|------------------|-------|-----------------|--|--|
| 1 | REFIN | 1.8V CMOS Input | Reference Clock Input | |
| 9 | VIN | Analog Input | VCXO Control Voltage - VIN has a positive control slope; that is, increasing the voltage on VIN causes the output frequency to increase The nominal output frequency is determined when VIN = 1.65V | |
| 13 | CLK | CMOS Output | 27 MHz Output Clock | |
| 11, 16 | DNU | _ | Do Not Use: DNU pins are electrically connected, but perform no function | |
| 5, 6, 10, 12, 14 | NC | _ | No Connect: NC pins are not connected to the die | |
| 2, 3, 4 | VDD | Power | Supply Voltage: 3.3V | |
| 7, 8, 15 | VSS | Power | Ground | |



Frequency Table

| Input | Output Frequency (MHz) | |
|---------------------------|------------------------|--------------------------|
| Reference Frequency (MHz) | PLL Multiplier Value | Output Frequency (Wiriz) |
| 27 | 1 | 27 |

VCXO and VIN

The output frequency of the device is adjusted over a limited range by use of the VCXO feature. This feature is typically used to phase and frequency lock to a separate reference clock. The frequency is controlled by the analog voltage on the VIN pin. The nominal output frequency is generated when VIN = 1.65V. As the voltage on VIN is increased, the output frequency increases. The voltage range for VIN is from 0V (VSS) to VDD. The relationship between output frequency (ppm) to VIN voltage is very linear over a large portion of the control voltage range.

Application Information

Power Supply Filtering Techniques

As in any high speed analog circuitry, noise on the power supply pins can degrade device performance. For general power plane decoupling, make certain there is at least one tantalum capacitor (~5 to 10 μF) in the general vicinity of this device. Additionally, ensure there is one or two multi-layer ceramic chip capacitors (0.01 or 0.1 μF) located as close as possible to the power and ground pins of the device. Ensure the layout is optimized to minimize power and ground inductance and locate the capacitor as close to the device pins as possible.

Absolute Maximum Conditions

| Parameter | Description | Condition | Min | Max | Unit |
|--------------------------------|-----------------------------------|-----------------------------|------|-----------------------|------|
| V_{DD} | Supply Voltage | | -0.5 | 4.4 | V |
| V _{IN} ^[1] | Input Voltage, DC | Relative to V _{SS} | -0.5 | V _{DD} + 0.5 | V |
| T _S | Temperature, Storage | Non operating | -65 | 150 | °C |
| T _J | Temperature, Junction | | _ | 125 | °C |
| ESD _{HBM} | ESD Protection (Human Body Model) | JEDEC STD 22-A114-B | 2000 | _ | V |
| UL-94 | Flammability Rating | At 1/8 in | V-0 | | |
| $\Theta_{JA}^{[2]}$ | Thermal Resistance, Junction to | 0 m/s airflow | 8 | 34 | °C/W |
| | Ambient | 1 m/s airflow | 79 | | |
| | | 2.5 m/s airflow | 7 | 76 | |

Operating Conditions

| Parameter | Description | | Тур | Max | Unit |
|-------------------|---|-------|-----|-------|------|
| V_{DD} | Supply Voltage Range | 3.135 | 3.3 | 3.465 | V |
| T _A | Ambient Temperature | 0 | _ | 70 | °C |
| T _{PU} | Power up time for V_{DD} to reach minimum specified voltage (ensure power ramp is monotonic) | 0.05 | _ | 500 | ms |
| C _{LOAD} | Load Capacitance on CLK output | - | 1 | 15 | pF |

Notes

1. The voltage on any input or output pin cannot exceed the power pin during power up.

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Simulated using Apache Sentinel TI software. The board is derived from the JEDEC multilayer standard. It measures 76 x 114 x 1.6 mm and has 4-layers of copper (2/1/1/2 oz.). The internal layers are 100% copper planes, while the top and bottom layers have 50% metalization. No vias are included in the model.



DC Electrical Characteristics

| Parameter | Description | Condition | Min | Тур | Max | Unit |
|--------------------------------------|---|---|---------------------|-----|---------------------|------|
| I _{DD} | Operating Supply Current | V _{DD} = 3.465V, output unloaded | _ | - | 110 | mA |
| V _{OH} | High Output Voltage | $V_{DD} = min, I_{OH} = -4 mA$ | 0.9*V _{DD} | - | - | V |
| V _{OL} | Low Output Voltage | $V_{DD} = max$, $I_{OL} = 4 mA$ | _ | - | 0.1*V _{DD} | V |
| V _{IH} | Input High Voltage | For REFIN | 1.25 | - | 1.8 | V |
| V _{IL} | Input Low Voltage | For REFIN | _ | _ | 0.25 | V |
| V _{VIN} | VIN Input Voltage | | 0 | _ | V_{DD} | V |
| I _{VIN} | VIN Input Current | $V_{SS} \le VIN \le V_{DD}$ | -10 | _ | 60 | μΑ |
| INL _{VIN} ^[3, 4] | VIN to F _{OUT} Integral Nonlinearity | $V_{SS} \le VIN \le V_{DD}$ | _ | 1 | _ | % |

AC Electrical Characteristics [3]

| Parameter | Description | Test Conditions | Min | Тур | Max | Unit |
|-------------------|------------------|---|------|-----|-----|------|
| F _{OUT} | Output Frequency | | _ | 27 | _ | MHz |
| PR | Pull Range | $VIN = V_{DD}$ to V_{SS} , relative to nominal f_{OUT} ($VIN = 1.65V$) across operating temperature and supply voltage. | ±115 | _ | _ | ppm |
| T _{DC} | Duty Cycle | Measured at V _{DD} /2, defined in Figure 2 | 45 | 50 | 55 | % |
| T _R | Output Rise Time | 20% to 80% of V _{DD} , C _{LOAD} = 15 pF | _ | 0.7 | 1.5 | ns |
| T _F | Output Fall Time | 80% to 20% of V _{DD} , C _{LOAD} = 15 pF | _ | 0.8 | 1.5 | ns |
| T _{LOCK} | Start Up Time | Time for CLK to reach valid frequency measured from the time $V_{DD} = V_{DD}$ (min) | - | _ | 5 | ms |

Parameter Measurements

Figure 2. Output Duty Cycle Timing

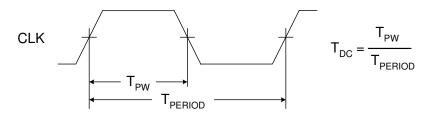
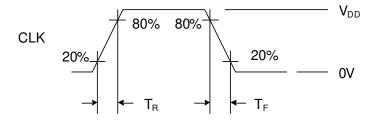


Figure 3. Output Rise and Fall Time



- Not 100% tested, guaranteed by design and characterization.
 Integral nonlinearity is defined in IEEE Standard 1241-2000.

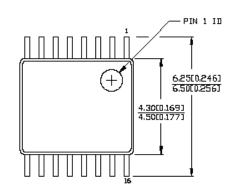


Ordering Information

| Part Number | Package Description | Product Flow | |
|--------------|------------------------------|------------------------|--|
| Pb-Free | | | |
| CY2VC511ZXC | 16-Pin TSSOP | Commercial, 0° to 70°C | |
| CY2VC511ZXCT | 16-Pin TSSOP - Tape and Reel | Commercial, 0° to 70°C | |

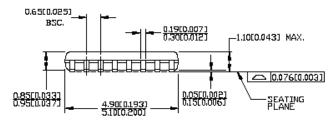
Package Drawings and Dimensions

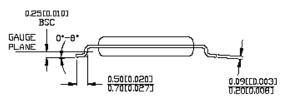
Figure 4. 16-Pin TSSOP 4.40 mm Body



DIMENSIONS IN MM(INCHES) MIN. MAX. REFERENCE JEDEC MO-153 PACKAGE WEIGHT 0.05gms

| PART # | | | |
|----------|-----------------------|--|--|
| Z16,173 | Z16.173 STANDARD PKG. | | |
| ZZ16.173 | LEAD FREE PKG. | | |





51-85091 *B



Document History Page

| Rev. | ECN No. | Orig. of Change | Submission Date | Description of Change |
|------|---------|--------------------|--------------------|---|
| ** | 506248 | RGL | See ECN | New data sheet |
| *A | 1285703 | JWK/KVM/ ARI | See ECN | Changed definition of nominal frequency to VIN = $1.65V$ Added C_{LOAD} specification Changed R_{UP} value Corrected T_R/T_F conditions and specification Removed pull down resistor on SEL Updated several drawings Edited data sheet for template compliance |
| *B | 2705638 | XHT/KVM/ AESA | 05/13/2009 | Changed title from Low Noise Clock Generator with VCXO to 27 MHz Clock Generator with VCXO, Basic configuration change: Reference changed from crystal to driven clock, Output changed from 216 MHz to 27 MHz, Pinout changed to show no connects, Pin 11 changed to DNU, V_{DD} range changed from ±0.2V to ±5%, Thermal resistance data added, IOL & IOH changed from 2mA to 4mA Phase noise specs removed, IIVIN changed from 10 μ A to 60 μ A, Rise & fall times changed, IDD changed |
| *C | 2768029 | KVM | 09/18/2009 | Remove reference to OE/PD# pin in I_{DD} spec Change parameter name I_{IVIN} to I_{VIN} Change parameter LIN to INL_{VIN} , add note to definition Add max limit for I_{R} , I_{F} : 1.5 ns Change I_{LOCK} max from 10 ms to 5 ms |
| *D | 2905106 | KVM | 05/14/10 | Updated package diagram. |



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